

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

## SSM6N16FE

High Speed Switching Applications  
Analog Switching Applications

- Suitable for high-density mounting due to compact package
- Low on resistance:  $R_{on} = 3.0 \Omega$  (max) (@ $V_{GS} = 4 \text{ V}$ )  
:  $R_{on} = 4.0 \Omega$  (max) (@ $V_{GS} = 2.5 \text{ V}$ )  
:  $R_{on} = 15 \Omega$  (max) (@ $V_{GS} = 1.5 \text{ V}$ )

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

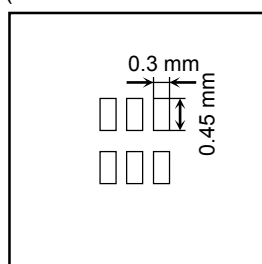
(Q1, Q2 Common)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		$V_{DS}$	20	V
Gate-Source voltage		$V_{GSS}$	$\pm 10$	V
Drain current	DC	$I_D$	100	mA
	Pulse	$I_{DP}$	200	
Drain power dissipation ( $T_a = 25^\circ\text{C}$ ) (Note 1)		$P_D$	150	mW
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55 to 150	$^\circ\text{C}$

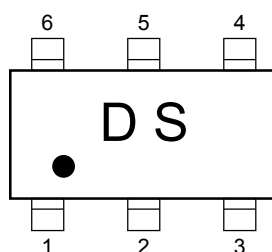
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

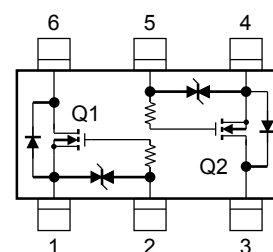
Note 1: Total rating, mounted on FR4 board  
(25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm, Cu Pad: 0.135 mm<sup>2</sup>  $\times$  6)



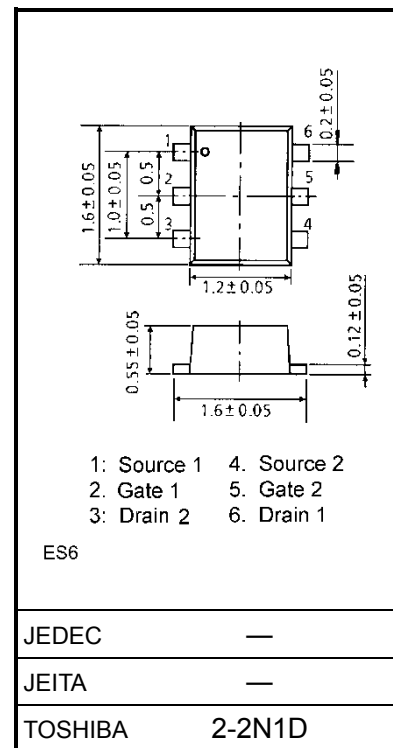
### Marking



### Equivalent Circuit



Unit: mm



Weight: 3.0 mg (typ.)

### Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

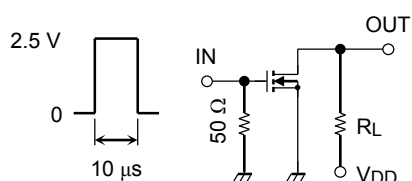
Start of commercial production  
2001-03

## Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 1$	$\mu\text{A}$
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = 0.1 \text{ mA}, V_{GS} = 0 \text{ V}$	20	—	—	V
Drain cut-off current	$I_{DSS}$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	1	$\mu\text{A}$
Gate threshold voltage	$V_{th}$	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.6	—	1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$	40	—	—	mS
Drain-Source ON resistance	$R_{DS(ON)}$	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$	—	1.5	3.0	$\Omega$
		$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$	—	2.2	4.0	
		$I_D = 1 \text{ mA}, V_{GS} = 1.5 \text{ V}$	—	5.2	15	
Input capacitance	$C_{iss}$	$V_{DS} = 3 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	9.3	—	pF
Reverse transfer capacitance	$C_{rss}$		—	4.5	—	pF
Output capacitance	$C_{oss}$		—	9.8	—	pF
Switching time	Turn-on time	$V_{DD} = 3 \text{ V}, I_D = 10 \text{ mA},$ $V_{GS} = 0 \text{ to } 2.5 \text{ V}$	—	70	—	ns
	Turn-off time		—	125	—	

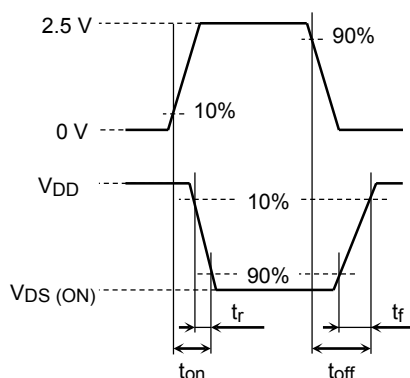
## Switching Time Test Circuit

(a) Test circuit



$V_{DD} = 3 \text{ V}$   
 Duty  $\leq 1\%$   
 $V_{IN}$ :  $t_r, t_f < 5 \text{ ns}$   
 $(Z_{out} = 50 \Omega)$   
 Common Source  
 $T_a = 25^\circ\text{C}$

(b)  $V_{IN}$



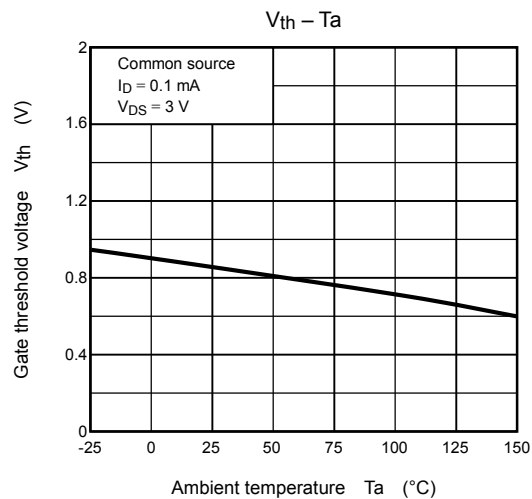
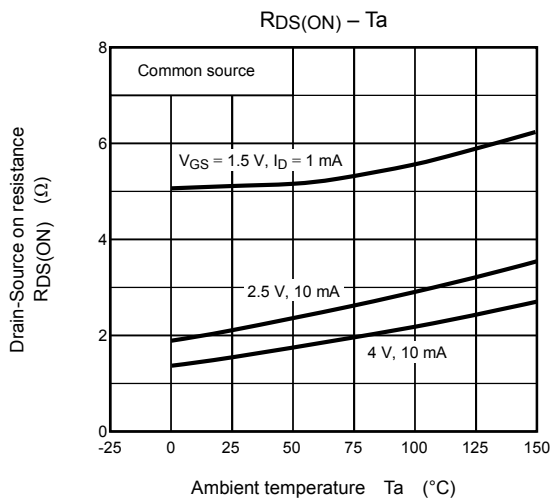
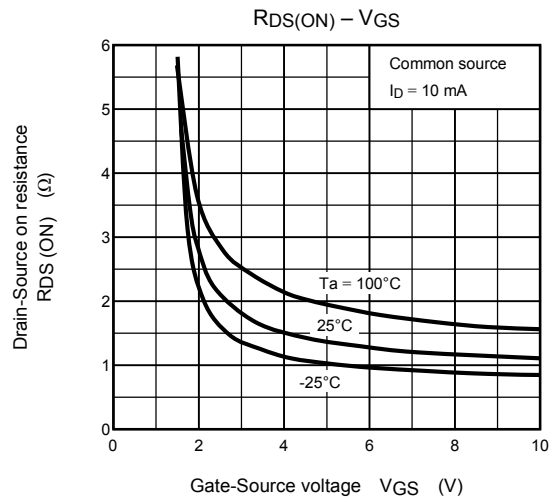
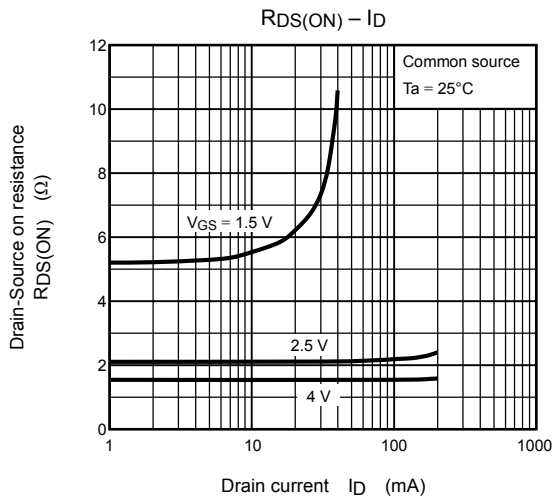
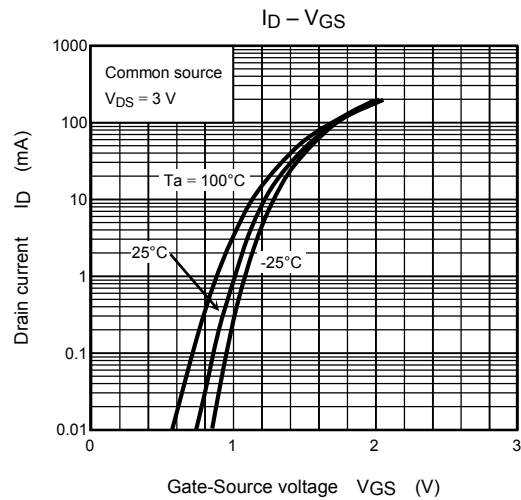
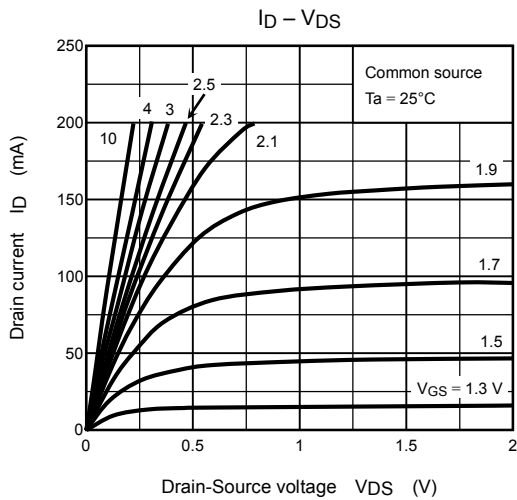
(c)  $V_{OUT}$

## Precaution

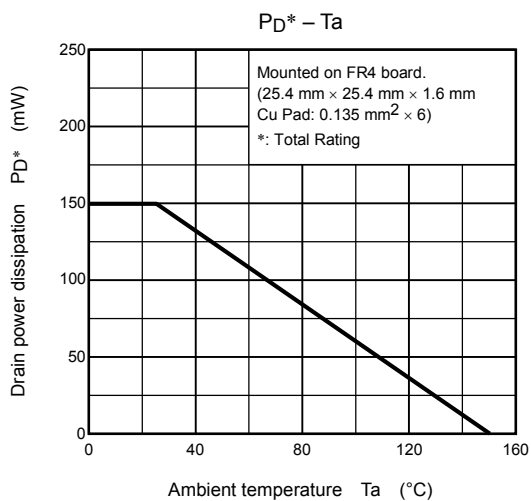
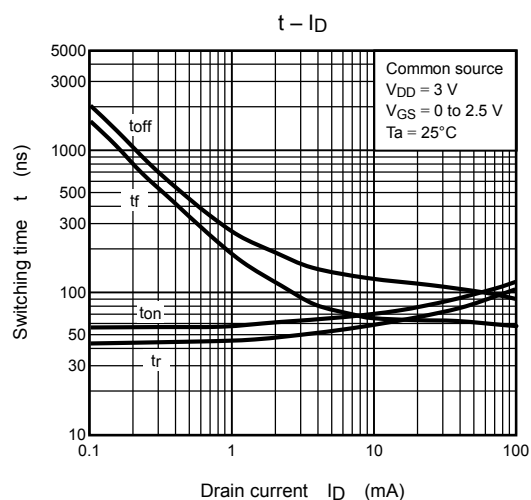
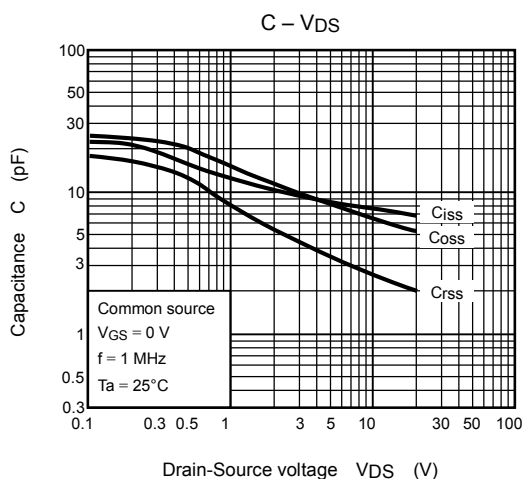
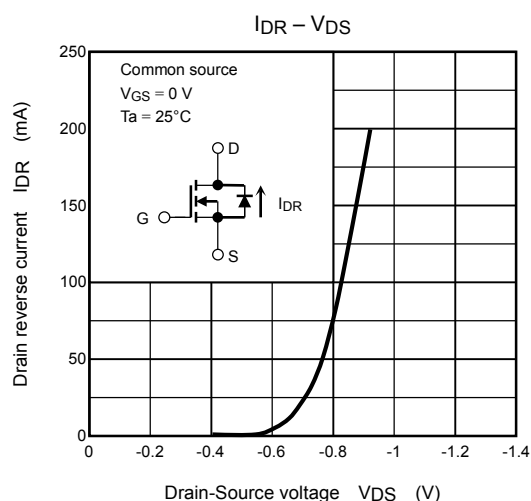
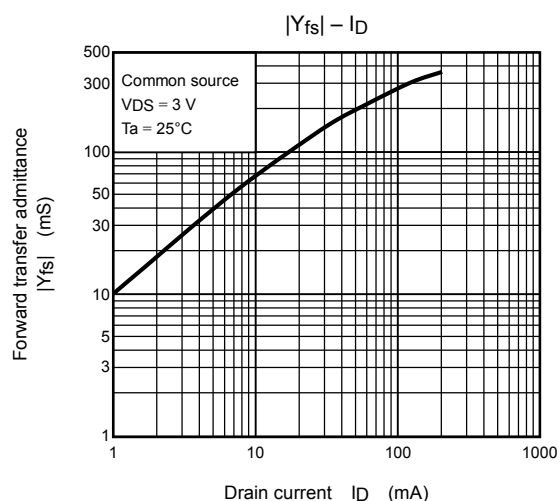
$V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D = 100 \mu\text{A}$  for this product. For normal switching operation,  $V_{GS(on)}$  requires higher voltage than  $V_{th}$  and  $V_{GS(off)}$  requires lower voltage than  $V_{th}$ . (Relationship can be established as follows:  $V_{GS(off)} < V_{th} < V_{GS(on)}$  )

Please take this into consideration for using the device.

(Q1, Q2 common)



(Q1, Q2 common)



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